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DATA SHEET

MLG25S-1175A10501

MLG-2
Automation light grids

SICK Sensor Intelligence

AUTOMATION LIGHT GRIDS

MLG25S-1175A10501

ORDERING INFORMATION

Type	part no.
MLG25S-1175A10501	1217113

Further device versions and accessories at www.sick.com/MLG-2



Illustration may differ



DETAILED TECHNICAL DATA

FEATURES

Device version	Prime - Standard functionality	
Sensor principle	Sender/receiver	
Minimum detectable object (MDO)	29 mm ¹⁾	
Beam separation	25 mm	
Type of synchronization	Optical	
Number of beams	48	
Detection height	1,175 mm	
Software features (default)	Q _{A1}	Height measurement (first beam)/FBB
	Q _{A2}	Height measurement (last beam)/LBB
	Q ₁	Presence detection
	inverted	—
	Teach	—
Operating mode	Standard	✓
Function	Cross beam	✓
	Beam blanking	✓
Applications	Switching output	Object detection Object recognition Height classification
	Data interface	Object detection

¹⁾ Depending on beam separation without cross beam setting.

	Object height measurement
Included with delivery	1 × sender 1 × receiver 4/6 × QuickFix brackets (6 × QuickFix brackets for monitoring heights above 2 m) 1 × Quick Start Guide

¹⁾ Depending on beam separation without cross beam setting.

MECHANICS/ELECTRONICS

Light source	LED, Infrared light
Wave length	850 nm
Supply voltage V_s	DC 19.2 V ... 28.8 V ¹⁾
Power consumption sender	57.4 mA ²⁾
Power consumption receiver	129.6 mA ²⁾
Ripple	< 5 V _{pp}
Output current I_{max}	100 mA
Output load, capacitive	100 nF
Output load, Inductive	1 H
Initialization time	< 1 s
Switching output	Push-pull: PNP/NPN
Connection type	Plug, M12, 5-pin, 0.22 m
Housing material	Aluminum
Display	LED
Enclosure rating	IP65, IP67 ³⁾
Circuit protection	U_v connections, reverse polarity protected Output Q short-circuit protected Interference pulse suppression
Protection class	III
Weight	2.649 kg
Front screen	PMMA
Option	None
UL File No.	NRKH.E181493

¹⁾ Without load.

²⁾ Without load with 24 V.

³⁾ Operating in outdoor condition only with a external protection housing.

PERFORMANCE

Maximum range	7 m ¹⁾
Minimum range	≥ 0.2 m
Operating range	5 m
Response time	7 ms

¹⁾ No reserve for environmental issue and deterioration of the diode.

INTERFACES

IO-Link	✓, IO-Link V1.1
Data transmission rate	38,4 kbit/s (COM2)
Maximum cable length	20 m
Cycle time	6 ms
VendorID	26
DeviceID HEX	800067
DeviceID DEC	8388711
Process data length	6 Byte (TYPE_2_V) ¹⁾
-	✓, Current
Inputs/outputs	2 x analog + 1 x Q (IO-Link)
Analog output (current)	4 mA ... 20 mA
Analog output	Q _{A1} , Q _{A2}
Number	2
Type	Current output
Current	4 mA ... 20 mA
Digital output	Q ₁
Number	1

¹⁾ For an IO-Link master with V1.0, reverts to interleaved mode (consisting of TYPE_1_1 (ProcessData) and TYPE_1_2 (on-request data)).

AMBIENT DATA

Shock resistance	Continuous shocks 10 g, 16 ms, 1000 shocks Single shocks 15 g, 11 ms 3 per axle
Vibration resistance	Sinusoidal oscillation 10-150 Hz 5 g
EMC	EN 60947-5-2
Ambient light immunity	Direct: 12,000 lx ¹⁾ Indirect: 50,000 lx ²⁾
Ambient operating temperature	-30 °C ... +55 °C
Ambient temperature, storage	-40 °C ... +70 °C

¹⁾ Outdoor mode.

²⁾ Light resistance indirect.

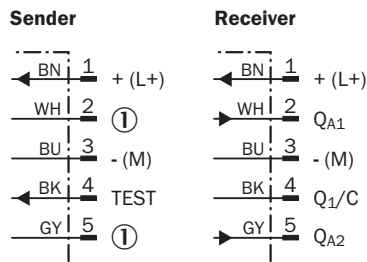
SMART TASK

Smart Task name	Base logics
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CERTIFICATES

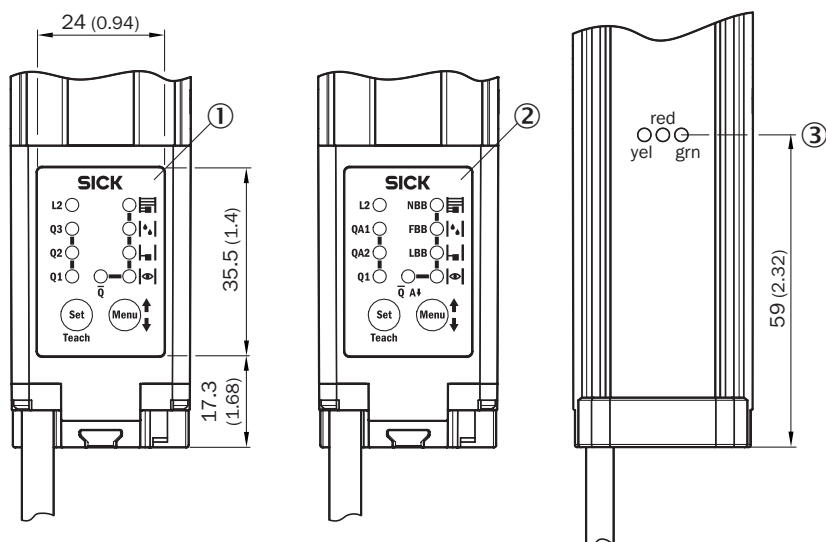
EU declaration of conformity	✓
UK declaration of conformity	✓
ACMA declaration of conformity	✓
Moroccan declaration of conformity	✓
China RoHS	✓
cULus certificate	✓
IO-Link certificate	✓
Photobiological safety (IEC EN 62471)	✓

CONNECTION TYPE AND DIAGRAM CONNECTOR M12, 5-PIN, ANALOG OUTPUTS Q_A



① Not assigned

ADJUSTMENTS



- ① MLG-2 with switching outputs Q
- ② MLG-2 with analog outputs Q_A
- ③ status indicator: green, yellow, red LEDs

FUNCTIONAL PRINCIPLE OPTICAL SYNCHRONIZATION



The sender and receiver synchronize with each other optically, so no electrical connection is necessary. For this reason, either the first or the last beam of the automation light grid must remain clear. If both beams are interrupted, no measurements can be taken.

- ① Optical synchronization
- ② Beam separation
- ③ scanning range

Further information as well as suitable accessories, example applications and downloads such as CAD dimensional models, operating instructions and software can be found at www.sick.com/1217113



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SICK AT A GLANCE

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SICK combines sensor intelligence with industry expertise and certified consulting services. We provide the ideal foundation for scalable as well as tailor-made automation solutions and create added value along the entire value chain. Our close partnerships with our customers are more than just a promise: Together, we optimize productivity, improve quality, protect health and safety, and help build a sustainable future. All with empathy and trust.

Since 1946, we have been developing innovative technologies with passion and a pioneering spirit. With a global network in around 40 countries, SICK has a global presence and is always close by. The company's headquarters are located in Waldkirch near Freiburg, Germany. Our customers benefit from our understanding of both local and global requirements, which enables us to deliver tailor-made solutions

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